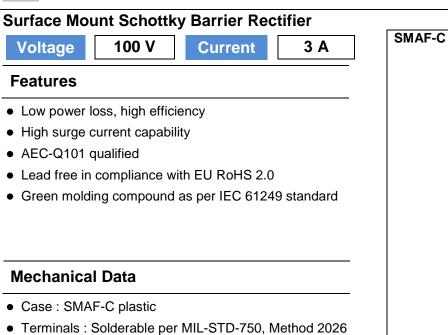


MBR310AFC-AU



• Approx. Weight : 0.0012 ounces, 0.034 grams

Maximum Ratings and Thermal Characteristics ($T_A = 25^{\circ}C$ unless otherwise noted)

Cathode

Anode

PARAMETER	SYMBOL	LIMIT	UNITS	
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	100	V	
Maximum RMS Voltage	V _{RMS}	70	V	
Maximum DC Blocking Voltage	V _{DC}	100	V	
Maximum Average Forward Rectified Current	I _{F(AV)}	3	А	
Peak Forward Surge Current : 8.3 ms Single Half Sine-Wave Superimposed On Rated Load	IFSM	80	A	
Typical Junction Capacitance Measured at 1 MHz And Applied $V_R = 4V$	CJ	120	pF	
(Note 1)	R _{θJA}	150		
Typical Thermal Resistance (Note 2)	R _{θJC}	22	°C/W	
(Note 3)	R _{θJL}	20		
Operating Junction Temperature Range	TJ	-55 to +150	°C	
Storage Temperature Range	Tstg	-55 to +150	°C	



Electrical Characteristics (T_A = 25^oC unless otherwise noted)

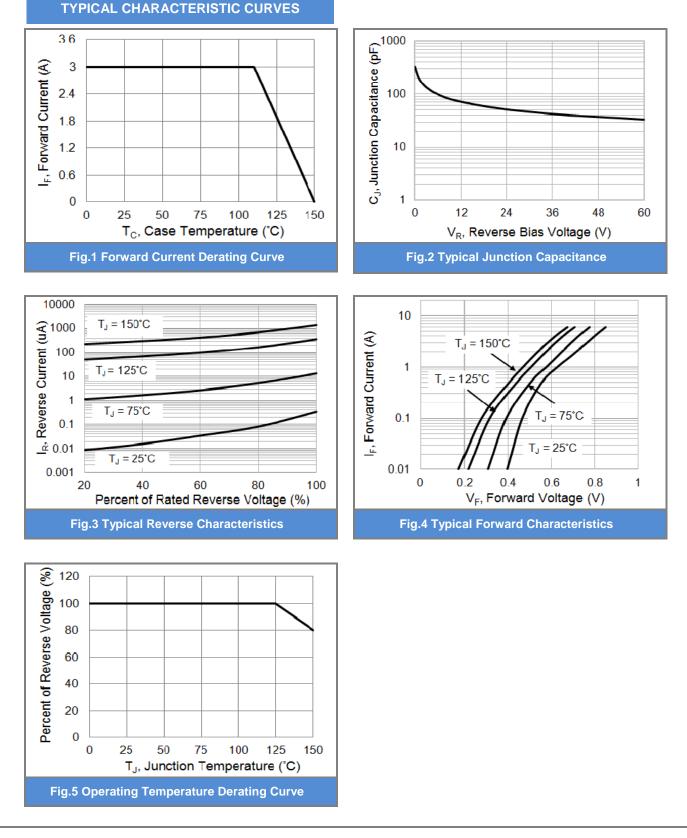
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Forward Voltage	VF	$I_F = 1 \text{ A}, T_J = 25 ^{\circ}\text{C}$	-	0.63	-	V
		$I_F = 3 \text{ A}, T_J = 25 ^{\circ}\text{C}$	-	-	0.8	
		I _F = 1 A, T _J = 125 °C	-	0.47	-	
		$I_F = 3 \text{ A}, T_J = 125 ^{o}\text{C}$	-	0.59	-	
Reverse Current ^(Note 4)	IR	V _R = 80 V, T _J = 25 °C	-	0.1	-	uA
		$V_R = 100 \text{ V}, \text{T}_J = 25 ^{\circ}\text{C}$	-	-	50	
		V _R = 100 V, T _J = 125 °C	-	0.3	-	mA

NOTES:

- 1. Mounted on a FR4 PCB, single-sided copper, standard footprint
- 2. Mounted on a FR4 PCB, single-sided copper, with 100 cm² copper pad area
- 3. Mounted on a FR4 PCB, single-sided copper, with 48 $\rm cm^2$ copper pad area
- 4. Short duration pulse test used to minimize self-heating effect







MBR310AFC-AU





MBR310AFC-AU

Part No. Packing Code Version

Part No. Packing Code	Package Type	Packing Type	Marking	Version
MBR310AFC-AU_R1_000A1	SMAF-C	3K / 7" reel	MBR310	Halogen free

Packaging Information & Mounting Pad Layout

